

### Test and Evaluation/Science and Technology Program

# **Embedded Instrumentation** NOVA Technology Enabled T&E Process





Makel Engineering, Inc.





Transformation"











































## T&E/S&T Program

- Leverages successful applied research and ongoing advanced technology development by transitioning S&T efforts from labs, academia, and industry to T&E capability developers and users
- Funds test technologies that keep pace with evolving weapons technology
- Ensures that we have the technology to adequately test future advanced systems



### T&E/S&T Program Background

### Program started in FY 2002

- Joint DDR&E/DOT&E initiative
- Transitioned to TRMC in February 2005

### Mission

- Develop new technologies required to test and evaluate our transforming military capabilities
  - Includes any system that makes our warfighters more survivable and effective in combat
    - Lethal and non-lethal weapons
    - Intelligence surveillance and reconnaissance
    - Information systems

#### Goal

Transition emerging technologies into test capabilities in time to verify warfighting performance



### T&E/S&T Program Mission

- Develop the technologies required to test and evaluate our transforming military capabilities
  - Includes any system that makes our warfighters more survivable and effective in combat:
    - Lethal and non-lethal weapons
    - > Intelligence, surveillance and reconnaissance systems
    - Information systems
- Provide the required test and evaluation technologies in time to verify performance before production or deployment into harm's way



# T&E/S&T Program

### Roles and Responsibilities

### Focus Area Executing Agents

- Primary point of contact for T&E/S&T Program Office within focus area
- Maintain awareness of DoD T&E needs within focus area and technology developments related to focus area
- Actively seek out high payoff T&E/S&T projects that address critical DoD T&E needs
- Issue Requests for Information (RFIs) and Broad Agency Announcements (BAAs) through contractual channels
- Responsible for technical and financial execution of projects approved by T&E/S&T Program Manager
- Chair for focus area working group (WG) and responsible for maintaining
   Tri-Service WG T&E and S&T representation
  - Coordinate replacements with T&E/S&T Program Manager
- Responsible for maintaining current project and focus area information in TESTWeb and T&E/S&T ACC Special Interest Area



# T&E/S&T Program

### Roles and Responsibilities

- Focus Area Working Group Members
  - Provide coordination of T&E/S&T projects with Service related efforts
  - Identify and prioritize T&E needs
  - Support the EA on source selection efforts
  - Review ongoing focus area projects
  - Identify transition opportunities for projects
- Project Principal Investigators
  - Single point of contact for executing projects approved by T&E/S&T Program Manager
  - Responsible for conducting research efforts
  - Responsible for maintaining accurate financial information in TESTWeb
  - Provide technical progress reports to EA and T&E/S&T Program Manager
  - Identify and actively pursue transition opportunities for T&E/S&T projects



# T&E/S&T Program Organization

#### **T&E/S&T Program Office**

G. Rumford (Program Manager)R. Barrett (Principal Engineer)Dr. M. Brown (Principal Scientist)D. Gaddy (Financial)

Hypersonic Test
J. Matty (EA)
Dr. B. Phillips (Deputy)

Subj Matter Expert Various

Financial

Tri-Service Working Group

#### **Spectrum Efficient**

Technology
S. Ortigoza (EA)
R. Streich (Deputy)

Subj Matter Expert Dr. D. Schaefer

**Financial** 

Tri-Service Working Group

#### **Multi-Spectral Test**

F. Carlen (EA)
L. Huynh (Deputy)

Subj Matter Expert Dr. S. Gontarek

Financial

Tri-Service Working Group Directed Energy Test
M. Vuong (EA)
A. Kapadia (Deputy)

Subj Matter Expert Various

**Financial** 

Tri-Service Working Group



Embedded
Instrumentation
Dr. G. Shoemaker (EA)
J. Hooper (Deputy)

Subj Matter Expert Dr. S. Zakanycz

Financial

Tri-Service Working Group

#### Netcentric Systems Test

R. Heilman (EA)
G. Torres (Deputy)

Subj Matter Expert
Various

Financial

Tri-Service Working Group



# A History of Warfare

The fundamental military strategy has always been the massing of force with a focus on "attrition warfare"

Unmanned combat vehicles, precision guided munitions, and full situational awareness signify the advent of "effectsbased warfare"

We have only just begun the "Technology Enabled Warfighting Transformation"



### **Current T&E Process**

CONTRACTOR DT TECHEVAL

OT OPEVAL FOT&E

LIMITED

ccurs on limited articles under limited

SELDOM

- OT occurs on limited articles under limited scenarios a limited number of times
- Many operational characteristics can only be ascertained over extended periods time and widely varying tactical scenarios
- Time, cost, and test resource availability are significant issues that impact effective OT

T&E is a cornerstone of acquisition

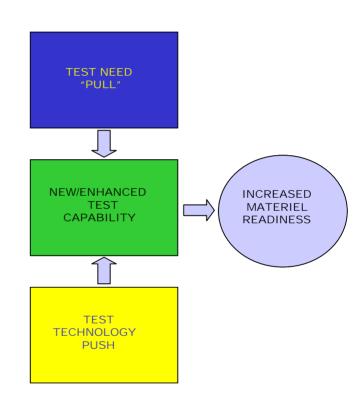


# **Test Capability Needs**

- Hard test requirements & needs are difficult to establish because of acquisition program financial accountability
- While warfighting systems can be driven by "technology push"

Advances in test technology seldom drive new test capability

 Test planning usually revolves around available test resources and capabilities





## **Test Capability Solutions**



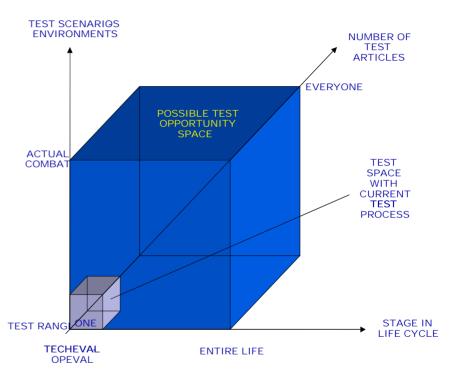
- There is always a need to balance risk with project executability
- Executability drives test capability solutions towards lower risk, more mature technologies

Without an infusion of new technology, test capabilities may not keep pace with the systems being tested



### T&E Vision for the Future of Embedded Instrumentation

- Test data is now collected for only a limited set of circumstances -Once
- El enables an expansion of the test opportunity space
  - To include all systems produced
  - For the full life of each system
  - From the DT/OT events to every training exercise and combat mission
- EI has the potential to transform the <u>T&E Process</u> from single discrete events to a continuous measurement cycle for each warfighting system



"Technology Enabled T&E Process Transformation"

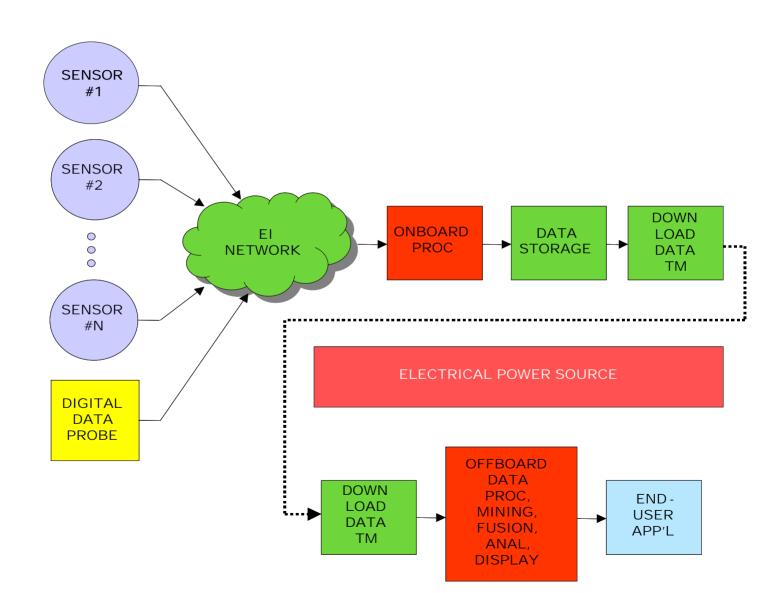


## **Embedded Instrumentation System**

An Embedded Instrumentation System (EIS) is an integrated suite of specialized components that provides information about a host system to a person or process who evaluates the information to make technical and/or programmatic decisions about the present and/or future design of the host system. The systems of concern include the warfighting system itself as well as all necessary supporting systems such as but not limited to test and evaluation, training and logistics support systems and may be a standalone systems, a subsystem thereof, or a system of such systems. It is characterized as performing its functions as an integrated part of the host system installed therein as part of the original system design or added separately (appliqué) after the basic host system design. The EIS components may be self-powered and are of such size and weight as to not impact the design, fabrication, and/or performance of the host system (non-intrusive). Further, integration is such that its mis-performance or failure does not in any way affect the performance of the host system.



## **Embedded Instrumentation System**



source intended to operate the EIS

electrical storage device and/or as a

independently of the host system. Power may be provided as a primary or secondary

generator. A generator may convert any form of potential or kinetic energy available

from the host system or the environment into electrical energy and/or provide for the

sympathetic absorption and conversion of

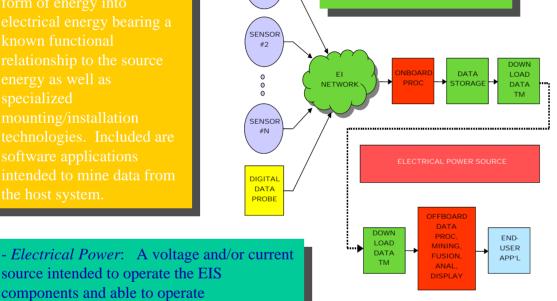
electrical power from the host system or any

components and able to operate

external energy field.

- Data Transport which moves data from the collection device to point in the EIS which may and/or telemetry system and includes the physical medium over which the data is transported as well as the and standards needed.

SENSOR

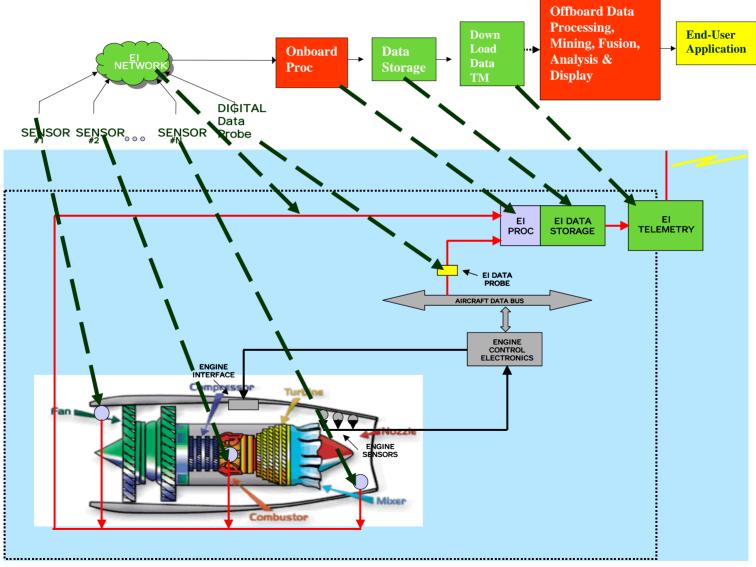


- On-Board Data Storage: Any technology located onboard the host system capable of storing analogue and/or digital data in raw or processed form for purposes of archiving, processing, and/or evaluation at a later time. It includes the storage medium as well as the read/write functionality of

- Data Telemetry: The function of transporting data and/or information off the host system in real-time or post-event to an end user as well as the offboard control of the EIS by the end user. TM is medium independent. The EI Focus includes the development of new technology for the establishment of a conventional TM capability and/or miniaturization and/or hardening of telemetry components as they reside on or in the host system but does not include the development of telemetry media or telemetry protocols and standards.
- Data Processing: The application of specialized algorithms implemented in hardware and/or software to prepare the data for transport, storage and/or telemetry as well as processing, analysis, evaluation, and display. It includes but is not limited to data reduction/compression, fusion, and encryption. Processing may take place on or in the host system or offboard the host system.



# **Example EIS Integration**





### **Embedded Instrumentation Vision**

- Develop and demonstrate non-intrusive embedded instrumentation sensors, power sources, data storage technologies and architecture concepts that enhance T&E of warfighting systems, reduce the cost of data collection and improve interoperability and standardization on ranges. Specific objectives include:
  - Sensing and collecting critical test performance data
  - Enhancing data storage and transmission
  - Determining high accuracy and continuous time, space, position, and attitude information
  - Interfacing with command and control data links
  - Monitoring and reporting all communications and their responses
  - Reporting human operator performance



# El Challenges and Approach

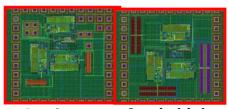
- Challenge: Instrumentation requirements for future systems-under-test and hardware-in-the-loop testing are increasing exponentially. Early involvement of Test and Evaluation in the acquisition cycle is essential.
- Approach: Develop enabling technologies for miniaturized non-intrusive instrumentation suites that demonstrate increased survivability.
  - improved sensitivity sensors
  - new demonstrations in alternative and micro-power generation to power test instrumentation
  - increased embedded data processing capacity
  - both plug-and-play and open architectures to support multiple applications and users (development, test and evaluation, training, logistics and operational employment).



## El Technology Overview

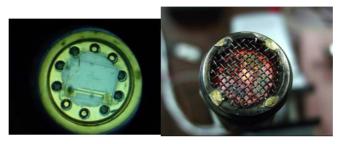
Micro-Sensors

#### **AMFTI**

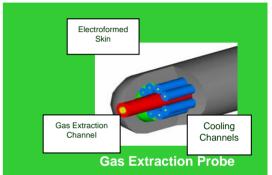


2-axis 3-axis high-g magnetometer accelerometer

#### **CO MEMS**



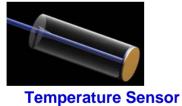
#### **GTE PROBE**

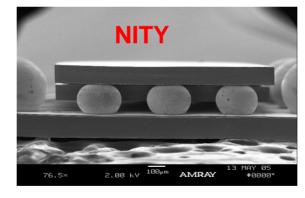




**MEMS FO** 

**SENSORS** 

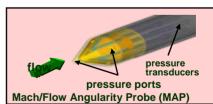


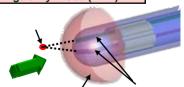


Total Temperature Probe (TTP)

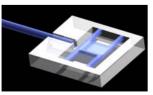
flow

ceramic optical blackbody radiation shield









**Shear Stress Sensor** 



HEDFS



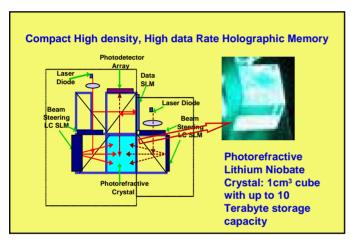
**FSIM** 

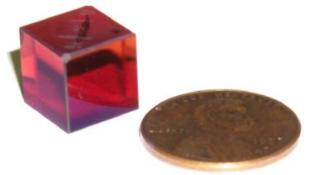


# El Technology Overview

### **Advanced Data Storage**

#### **HOLO CUBE**



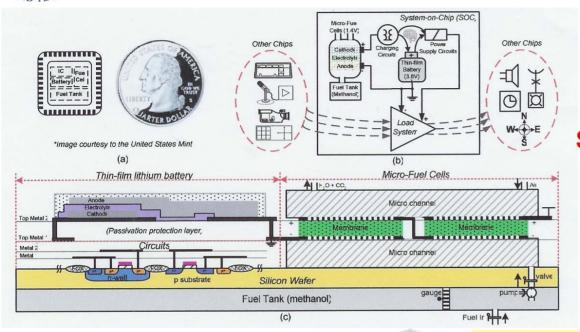




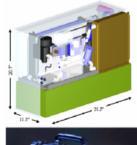


### El Technology Overview

### **Advanced Power Sources**



Self-Powered Chip





#### System Specifications Output Voltage: 20 to 30 V Power: 300 W Max Current: 15 A Power Source Dimensions: 31.5 in x 20.7 in x 11.5 in Mass: 55.6 kg (122.6 lb) Volume: 123 L (4.3 ft3) Figures of Merit: 539.5 Whr/kg, 243 Whr/L Fuel Cell System System Mass: 17.7 kg (39 lb) Fuel: Methanol(Supplied from internal fuel tank) Capacity: 30000 Whr Tank Volume: 32 L (1.1 ft3) Fuel Mass: 25.2 kg (55.5 lb) Air Quality: High dust concentration, 20 times zero visibility (~ 5 gm/m² of ACS Coarse 30 microns dust) System Startup: Instantaneous when ambient temperature is greater than 5 °C (41 °F) Wet Storage: 5 to 70 °C (158 °F) Air Temperature: -17 to 45 °C (113 °F)

Attitude Sensitivity: +/- 45° to vertical Shock and Vibration: Survive a three-foot drop on concrete

Unit must be protected during wash rack cycle.

# Direct Methanol Fuel Cell



The "Stack" (approx 16 in long)



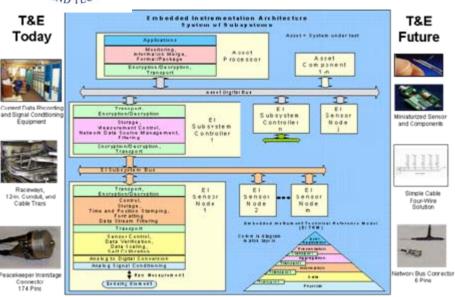
T&E

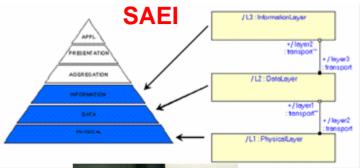
Equipment

Connector 174 Pins

# El Technology Overview

### **Architecture**



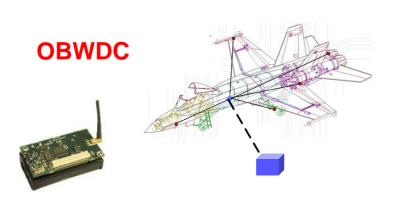


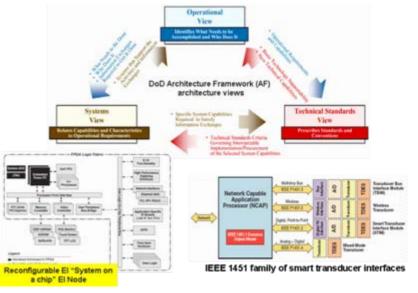




PC/104-based Embedded Demonstration Platform

### **DCTDB**

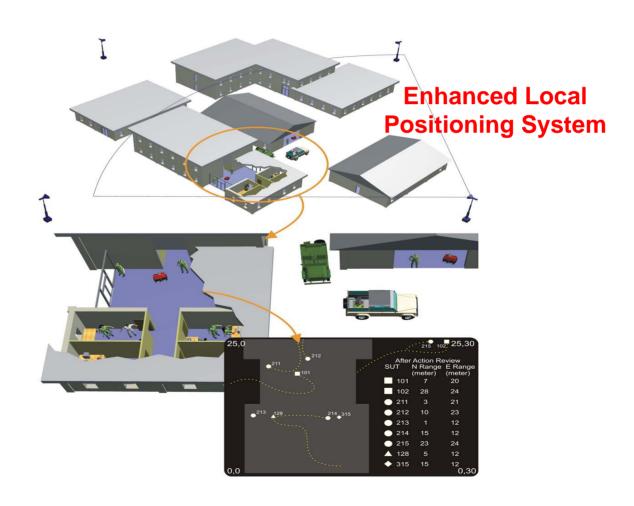




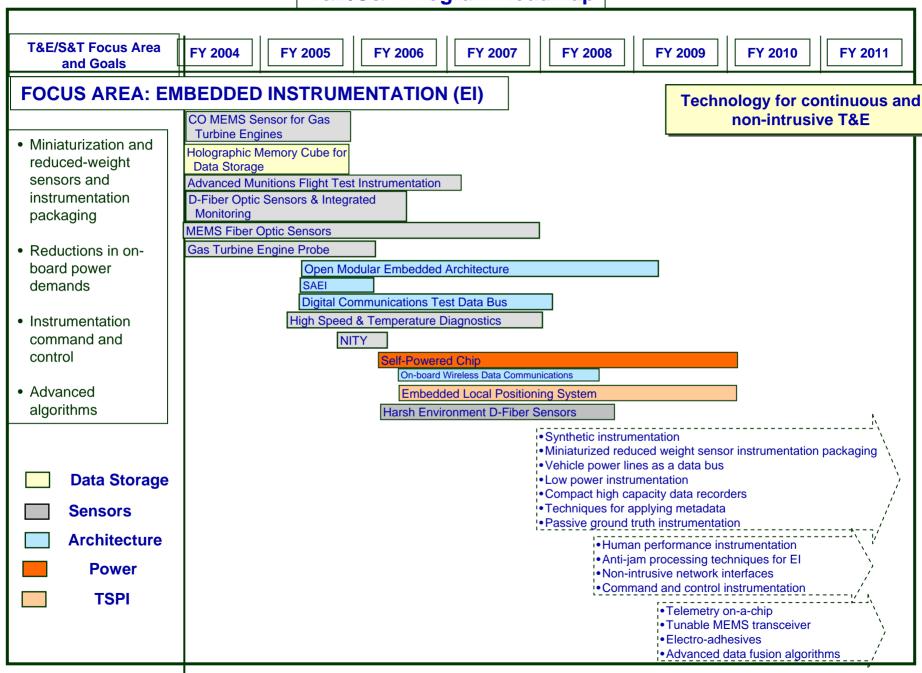
#### **OMEA**



# El Technology Overview TSPI



#### **T&E/S&T Program Roadmap**



# SENCE AND TECHNO

### T&E/S&T Program

### **Project Selection**









## Tri-Service Focus Area Working Group

- Executing Agent
- T&E Community Reps
- S&T Community Reps
- Subject Matter Experts

Needs/Requirements

BROAD AGENCY ANNOUNCEMENT
BAA 000-04-C-IPKD

EMBEDDED INSTRUMENTATION FOR TEST
AND EVALUATION

DATED: 15 JULY 2003

Project Manager: Lasa Davis
Technical Point of Contact: Saul Ortigoza
Contracting Officer: Senah Williams

PROGRAM RESEARCH AND DEVELOPMENT
ANNOUNCEMENT
FROA 000-04-C-PICD

SPECTRUM EFFICIENT TECHNOLOGIES FOR
TEST AND EVALUATION

DATED 9 JULY 2003

Project Manager Mr. Saul Origona
Contents Negonater Mr. Vacy Morris
Contents Negonater Mr. Saul Origona

Solicitations

Embedded Instrumentation for Test and Embedded Instrumentation for Test and Evaluation
Tachnolo
Tachno

**Proposals** 

# Program Manager

Final Selections

Executing Agent

Recommendations

Evaluation Team

Working Group

Subject Matter Experts

Source Selection

Contracting Reps

Focus Area Execution



### **FY07 BAA Plans**

### Two Step Process

- 3-page abstract due on 20 July 2006
- Specific focus areas of interest for FY 2007
  - Synthetic instrumentation
  - Miniaturization/reduced weight sensor and instrumentation packaging
  - Connectivity
  - Non-conventional power sources
  - Micro-power sources
  - Techniques for applying metadata
  - Self-describing smart sensors
  - TSPI on a chip
  - Micro-sensors

### Next Step

- Government will invite proposals after abstract evaluations on 7 August 2006 (You may still submit a proposal even if you don't receive an invitation letter. It will be evaluated without prejudice).
- 25-page technical/management proposal due September 07 2006
- EIWG proposal evaluations mid September 2006
- Recommendations to PMO in October 2006
- Awards in November-December 2006

#### **Broad Agency Announcement**: EI BAA 1234

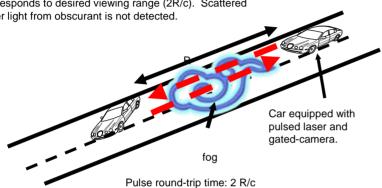
#### Principal EI Component Area: Sensors

Principal Investigator: Dr. Simon Simon

**Proposal Title**: Enhanced Infrared Sensor for Obscured Viewing Conditions

#### **Enhanced IR Sensor Operating Principle**

Emit ~ 20 ns laser pulse; gate camera at a time that corresponds to desired viewing range (2R/c). Scattered laser light from obscurant is not detected.



#### **Operational Capability to Be Provided:**

The Enhanced Infrared Sensor will be capable of providing illumination for a large area during fog or smoke conditions with infrared light The sensor is connected to a high-density recorder.

System uses sophisticated camera design and gated laser sampling techniques. The Enhanced IR Sensor has the following operational capabilities:

- Ability to penetrate fog and smoke conditions to produce a "gated view"
- Calculated MBTF of this technology is well beyond 20,000 hours
- Ability to form variety of beam patterns at different power levels
- Exceeds current state-of-the-art for eye safety margin by 10x
- Supports calculation of range to viewed objects

#### **Proposed Technical Approach:**

#### Task 1

- Engineering Design and Development
- · Requirements definition
- HW/SW development
- · Produce a brassboard test unit

#### •Task 2

- System Integration and Laboratory testing
- Interim Report

#### Task 3

• Field Testing enhanced infrared sensor

#### Task 4

Sensor packaging and delivery



#### **ROM Cost and Schedule:**

Task	Time Period	Cost	
Task 1:	12 months	\$275k	Total Cost: \$580k
Task 2:	6 months	\$100k	
Task 3:	3 months	\$100k	
Task 4:	1 month	\$105k	

#### **Deliverables:**

- Interim report on Enhanced IR sensor brassboard laboratory testing
- Interim & final reports on the design & testing of the Enhanced IR sensor
- Prototype Enhanced IR Sensor, design drawings and software

#### **Corporate Information:**

Prime: XYZ Inc., 245 Chapman Street, Providence, RI 02905, Phone 401-xxx-xxxx, Fax 401-xxx-xxxx, ext 114, jjones@xyz.com

Team: ABC Company Research Laboratory, Anywhere, UT, John Jones, Phone,

Email

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# Abstract Page 2 Description of Technology

- Complete and concise description of technology you are proposing
- No background, theory or extraneous material is necessary



# Abstract Page 3

- T&E need
- Transition plan to support warfighting systems
- Brief assessment of the technical, performance and schedule risks



### Guidance for 6.3 S&T

### Appendix A to the BAA

- Miniaturization and hardening of prototype devices to facilitate technology demonstration
- Proof of technology feasibility and assessment of component operability and producibility
- Assessment of emerging COTs technologies potentially applicable to T&E
- Direct relevance to military test need
- Test/demonstration in laboratory, simulation and/or field environment
- Evaluation of architectures that facilitate the integration of El system components



# Bidder Challenges

- Ensure appropriate amount of S&T (6.3) content to your proposal
- Address a valid test & evaluation need
- Establish an effective transition opportunity
- High risk, high payoff technology
- Non-intrusive instrumentation
  - Minimal size
  - Extremely low weight
  - Low power
  - Affordable cost



### **BAA Points of Contact**

- Technical
  - Dr. George Shoemaker, (401)832-5304,
     <a href="mailto:shoemakergt@npt.nuwc.navy.mil">shoemakergt@npt.nuwc.navy.mil</a>
  - Rob White, (401) 832-4897whiterj@npt.nuwc.navy.mil
- Contracts
  - Nancy Howard, (401)832-1545,
     howardns@npt.nuwc.navy.mil
- Website
  - <a href="http://www.npt.nuwc.navy.mil/contract">http://www.npt.nuwc.navy.mil/contract</a>